

# **Internally Matched LNA Module**

#### **Features**

- · S<sub>21</sub> = 14.5 dB @ 1900 MHz = 13.9 dB @ 2000 MHz
- · NF of 0.8 dB over Frequency
- · Unconditionally Stable
- · Single 3.5V Supply
- · High OIP3 @ Low Current

#### **Description**

The plerow™ ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.







1-stage Single Type

# **Specifications (in Production)**

Typ. @ T = 25°C,  $V_s$  = 3.5 V, Freq. = 1950 MHz,  $Z_{o.sys}$  = 50 ohm

Parameter	Unit	Specifications			
Farameter	Offit	Min	Тур	Max	
Frequency Range	MHz	1900		2000	
Gain	dB	13.2	14.2		
Gain Flatness	dB		± 0.3	± 0.4	
Noise Figure	dB		0.8	0.85	
Output IP3 (1)	dBm	30	31		
S11 / S22 <sup>(2)</sup>	dB			-18 / -9	
Output P1dB	dBm	16	17		
Switching Time	μsec		-		
Supply Current	mA		25	35	
Supply Voltage	V		3.5		
Impedance	Ω	50			
Max. RF Input Power	dBm	C.W 23 ~ 25 (before fail)			
Package Type & Size	mm	Surface Mount Type, 10Wx10Lx3.8H			

### **More Information**

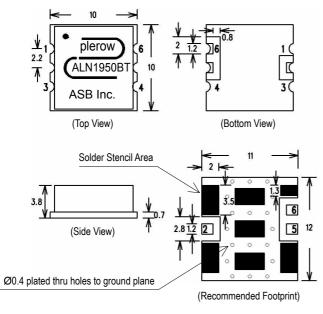
Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

ASB Inc., 4th Fl. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Operating temperature is -40°C to +85°C.

# **Outline Drawing (Unit: mm)**



Pin Number	Function		
2	RF In		
5	RF Out		
6	+Vcc		
Others	Ground		

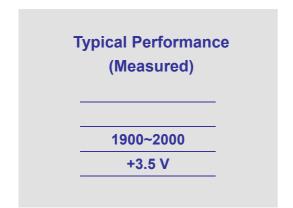
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.

2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

<sup>1)</sup> OIP3 is measured with two tones at an output power of 0 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V<sub>S</sub>.



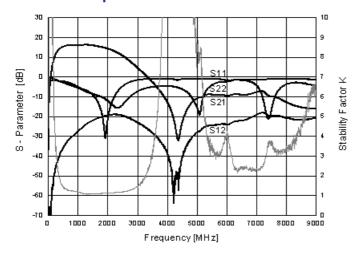
# **Internally Matched LNA Module**



#### 

**S-parameters** 

### S-parameters & K Factor



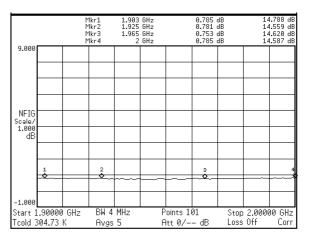
## **Noise Figure**

1940 1950 1960

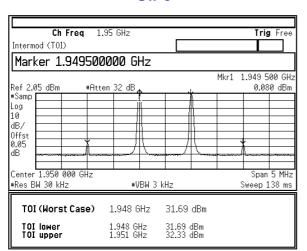
Frequency [MHz]

1970 1980 1990 2000

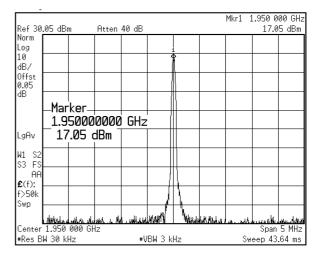
1900 1910 1920 1930



OIP3



## P1dB





# **RF Performance with Voltage Change**

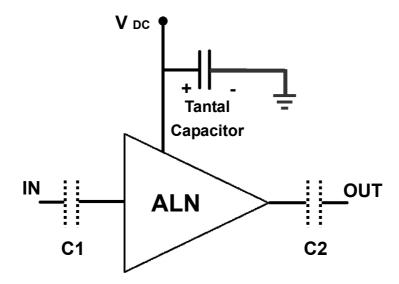
Item Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-18.3	-9.8	14.1	0.4	0.819	15.5	27.6	13
4.6	-18.9	-10.1	14.3	0.4	0.810	15.8	28.7	15
4.7	-19.5	-10.4	14.4	0.4	0.801	16.1	29.7	17
4.8	-19.6	-10.6	14.5	0.4	0.792	16.3	30.7	20
4.9	-20.0	-10.8	14.6	0.4	0.785	16.6	31.6	22
5.0	-20.3	-11.0	14.7	0.4	0.781	16.8	31.9	25
5.1	-20.3	-11.0	14.8	0.4	0.783	17.1	32.3	27
5.2	-20.3	-11.1	14.8	0.4	0.784	17.3	32.9	30
5.3	-20.4	-11.3	14.9	0.4	0.788	17.6	33.0	33
5.4	-20.4	-11.4	14.9	0.4	0.796	17.8	33.2	36
5.5	-20.4	-11.2	14.9	0.4	0.794	18.0	33.4	38

# **RF Performance with Operating Temperature**

Item Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-22.0	-10.8	14.8	0.4	0.492	17.2	31.9	20
- 20°C	-21.5	-10.8	14.7	0.4	0.572	17.2	31.8	22
0°C	-21.0	-10.9	14.7	0.4	0.648	17.0	32.1	23
25°C	-20.3	-11.0	14.7	0.4	0.781	16.8	32.9	25
40°C	-19.8	-10.9	14.6	0.4	0.840	16.7	32.3	26
60°C	-19.5	-10.9	14.5	0.4	0.949	16.5	32.2	27
80°C	-19.0	-10.8	14.4	0.4	1.028	16.3	32.0	27
100°C	-18.8	-10.8	14.3	0.4	1.149	16.0	31.8	27



## **Application Circuit**

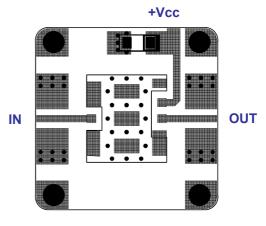


- 1) The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

## **Recommended Soldering Reflow Process**

# 260°C 20~40 sec | Ramp-up (3°C/sec) (6°C/sec) | | 200°C | | 60~180 sec |

### **Evaluation Board Layout**



Size 25 x 25mm (for ALN-AT, BT, T Series – 10x10mm)